DATA SHEET



MINIATURE SIGNAL RELAY

UA2/UB2 SERIES

SUPER-COMPACT SIZE, SLIM-PACKAGE

DESCRIPTION

NEXEM UA2/UB2 relay is a new generation miniature signal relay, super-compact and slim.

FEATURES

- ☐ Small mounting size of slim package for dense mounting
- □ Telcordia (2500 V) and FCC (1500 V) surge capacity
- ☐ IEC62368-1/ EN62368-1 spacing (Basic insulation class on 200 V working voltage)
- □ Low power consumption (100-230 mW)
- □ NZF type (high power switching) is UL recognized / CSA Certificated for 30VDC, 2A (resistive load), supports maximum switching power of 60 W and maximum switching and carrying current of 2 A.
- □ Moisture Barrier Bag (MBB) packaged UB2 relays meet moisture sensibility level (MSL) of IPC/JEDEC-STD-020, 075.

APPLICATIONS

Electronic switching systems, PBX, Terminal equipment, Telephone system





For Right Use of Miniature Relays

DO NOT EXCEED MAXIMUM RATINGS.

Do not use relays under exceeding conditions such as over ambient temperature, over voltage and over current. Incorrect use could result in abnormal heating, damage to related parts or cause burning.

READ CAUTIONS IN THE SELECTION GUIDE.

Read the cautions described in EM Devices' "Miniature Relays" when you choose relays for your application.

The information in this document is subject to change without notice.

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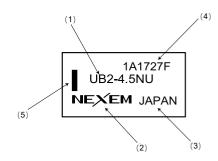
- •All specifications in this catalog and production status of products are subject to change without notice. Prior to the purchase, please contact EM Devices for updated product data.
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Unit: mm (inch)



MARKINGS (Top view)



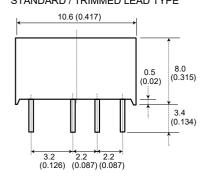
- Part number (1)
- Manufacturer (2)
- Country of origin (3)
- Date code (4)
 - Direction mark (pin No. 1 and 8)

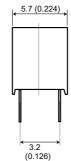
DIMENSIONS

UA2 SERIES

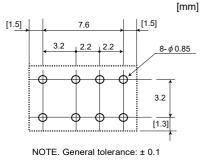
DIMENSIONS

STANDARD / TRIMMED LEAD TYPE





PAD LAYOUTS (Bottom view)



(Bottom view)

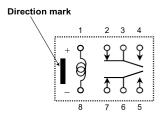
Tolerance of lead pitch is ± 0.15mm (0.006inch) Other tolerances ± 0.3mm (0.012inch)

Lead size 0.4 x 0.2 ± 0.1

Trimmed lead type: Lead length 2.8mm

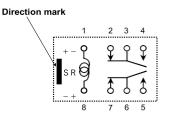
PIN CONFIGURATIONS (Bottom view)

Non-latch type



(Not energized position)

Single coil latch type



S: Coil polarity for Set R: Coil polarity for Reset

(Reset position)

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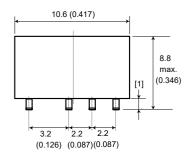
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UB2 SERIES

DIMENSIONS

STANDARD



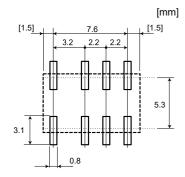
Tolerance of lead pitch is ±0.15mm (0.006inch) Other tolerances ±0.3mm (0.012inch) Coplanarity of terminals is 0.1mm Max.

5.7 (0.224) 3.2 (0.126) 7.4 (0.291)

Lead size 0.4x0.2 ±0.1

Unit: mm (inch)

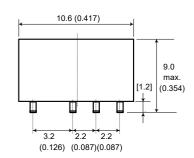
PAD LAYOUTS (Top view)



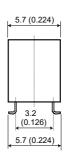
NOTE. General tolerance: ±0.1

[mm]

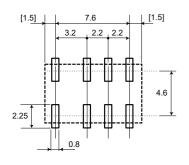
MINIMUM FOOTPRINT TYPE



Tolerance of lead pitch is ±0.15mm (0.006inch) Other tolerances ±0.3mm (0.012inch) Coplanarity of terminals is 0.1mm Max.



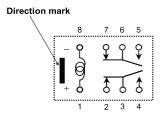
Lead size 0.4x0.2 ±0.1



NOTE. General tolerance: ±0.1 (Top view)

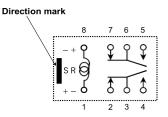
PIN CONFIGURATIONS (Top view)

Non-latch type



(Not energized position)

Single coil latch type



S: Coil polarity for Set R: Coil polarity for Reset

(Reset position)

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GENERAL SPECIFICATIONS

Contact Form		2 Form C	
	Standard	Silver alloy with gold alloy overlay	
Contact Material	High power switching type	Silver with gold alloy overlay	
Maximum Switching	Standard	30 W, 37.5 VA (resistive)	
Power	High power switching type	60 W, 37.5 VA (resistive)	
Maximum Switching	Voltage	220 VDC, 250 VAC	
Maximum Switching	Standard	1A	
Current	High power switching type	2 A	
Maximum Carrying	Standard	1 A	
Current	High power switching type	2 A	
Minimum Contact Ra	atings	10 m VDC, 10μA *1	
Initial Contact Resist	ance	100 m Ω max. (Initial)	
Operate Time [Set Time	e] (Excluding bounce)	Approx. 2 ms [2ms]	
Release Time [Rese	t Time] (Excluding bounce)	Approx. 1 ms [2ms] (Without diode)	
Insulation Resistance	9	1000 MΩ at 500 VDC	
	Between open contacts	1000 VAC (for one minute), 1500 V surge (10x160 μs *2)	
Withstanding Voltage	Between adjacent contacts	1000 VAC (for one minute), 1500 V surge (10x160 μs *2)	
Ü	Between coil and contacts	1800 VAC (for one minute), 2500 V surge (2x10 μs *3)	
Shock Resistance		735 m/s ² (75G) (misoperation)	
SHOCK Resistance		980 m/s² (100G) (destructive failure)	
Vibration Resistance		10 to 55 Hz, double amplitude 3 mm (196 m/s²) (misoperation) 10 to 55 Hz, double amplitude 5 mm (294 m/s²) (destructive failure)	
Ambient Temperatur	е	-40 to +85 °C	
Coil Temperature Ris	se	13 °C / 100mW, 18 °C / 140mW, 28 °C / 230mW at nominal coil Voltage	
	Non-load	5x10 ⁷ operations (Non-latch type) *4 1x10 ⁷ operations (latch type)	
Running		30 VDC 1A (resistive), 1x10 ⁵ operations at 20°C,1Hz	
Specifications	Load	125 VAC 0.3A (resistive), 1x10 ⁵ operations at 20°C,1Hz	
	(Only High power switching type)	30 VDC 2A (resistive), 5x10 ⁴ operations at 20°C,1Hz	
Weight		Approx. 1 g	

 $[\]mbox{\ensuremath{^{\star}}}$ 1 This value is a reference value in the resistive load.

Minimum capacity changes depending on switching frequency and environment temperature and the load.

^{* 2} rise time: 10µs, decay time to half crest: 160µs

^{* 3} rise time: 2µs, decay time to half crest: 10µs

^{* 4} This shows the number of operations with fatal defects. Stable characteristics are maintained for 1 × 10⁷ operations.

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COIL SPECIFICATIONS

Non-latch Type				at 20°C
Nominal	Coil	Must Operate	Must Release	Nominal
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power
(VDC)	(Ω)±10%	(VDC)	(VDC)	(mW)
3	64.3	2.25	0.3	140
4.5	145	3.38	0.45	140
5	178	3.75	0.5	140
9	579	6.75	0.9	140
12	1028	9.0	1.2	140
24	2504	18.0	2.4	230

Single Coil Latch Typ	e			at 20°C
Nominal	Coil	Set	Reset	Nominal
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power
(VDC)	(Ω)±10%	(VDC)	(VDC)	(mW)
3	90	2.25	2.25	100
4.5	202.5	3.38	3.38	100
5	250	3.75	3.75	100
9	810	6.75	6.75	100
12	1440	9.0	9.0	100

Note: Apply the coil voltage so that the No.1 pin is on the + side when set and the No.8 pin is on the + side when reset.

Non-latch Low Power	on-latch Low Power Consumption Type				
Nominal	Coil	Must Operate	Must Release	Nominal	
Coil Voltage	Resistance	Voltage*	Voltage*	Operating Power	
(VDC)	(Ω)±10%	(VDC)	(VDC)	(mW)	
3	90	2.25	0.3	100	
4.5	202.5	3.38	0.45	100	
5	250	3.75	0.5	100	

Note: * Test by pulse voltage

SAFETY STANDARD AND RATING

UL Recognized (UL508) * File No E73266	CSA Certificated (CSA C22.2 No14) ** File No LR46266
Standard	High power switching type
30 VDC, 1 A (Resistive)	30 VDC, 2 A (Resistive)
110 VDC, 0.3 A (Resistive)	110 VDC, 0.3 A (Resistive)
125 VAC, 0.3 A (Resistive)	125 VAC, 0.3 A (Resistive)

^{*} Spacing: UL840, **Spacing: CSA std950

TUV Certificate (EN61810-1)
No. 2050596 ***
Creepage and clearance of
coil to contact is more than 2 mm.
(According to EN62368-1)
Basic insulation class

^{***}High power switching type are not supported TUV certified.

RECOMMENDED RELAY DRIVE CONDITIONS

Drive under conditions.

Non-latch type	Voltage: within ±5% of nominal voltage	
Single coil latch type	Square pulse (rise and fall time is rapid) pulse height: within ±5% of nominal voltage pulse width: more than 10 ms	Ambient temperature - 40 to +85 °C

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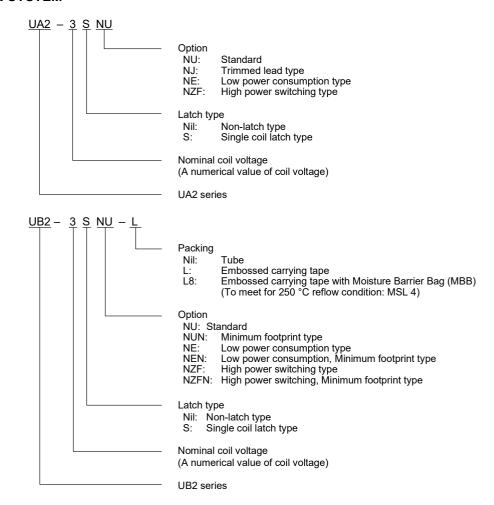
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PART NUMBER SYSTEM



ORDERING PART NUMBERS

□ UA2 series

Option		Nominal	Coil Type		
Terminal	Packing	Coil Voltage (VDC)	Non-latch	Single Coil Latch	Non-latch Low power consumption
		3	UA2-3NU	UA2-3SNU	UA2-3NE
		4.5	UA2-4.5NU	UA2-4.5SNU	UA2-4.5NE
Standard		5	UA2-5NU	UA2-5SNU	UA2-5NE
Standard		9	UA2-9NU	UA2-9SNU	-
		12	UA2-12NU	UA2-12SNU	-
	Tubo	24	UA2-24NU	-	-
	Tube	3	UA2-3NJ	UA2-3SNJ	-
		4.5	UA2-4.5NJ	UA2-4.5SNJ	-
Trimmed		5	UA2-5NJ	UA2-5SNJ	-
lead		9	UA2-9NJ	UA2-9SNJ	-
		12	UA2-12NJ	UA2-12SNJ	-
		24	UA2-24NJ	-	-

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□ UB2 series

Opt	tion			Coil Type	
Terminal	Packing	Nominal Coil Voltage (VDC)	Non-latch	Single Coil Latch	Non-latch Low power consumption
		3	UB2-3NU	UB2-3SNU	UB2-3NE
		4.5	UB2-4.5NU	UB2-4.5SNU	UB2-4.5NE
	Tube	5	UB2-5NU	UB2-5SNU	UB2-5NE
	Tube	9	UB2-9NU	UB2-9SNU	-
		12	UB2-12NU	UB2-12SNU	-
		24	UB2-24NU	-	-
		3	UB2-3NU-L	UB2-3SNU-L	UB2-3NE-L
		4.5	UB2-4.5NU-L	UB2-4.5SNU-L	UB2-4.5NE-L
0111	T	5	UB2-5NU-L	UB2-5SNU-L	UB2-5NE-L
Standard	Taping	9	UB2-9NU-L	UB2-9SNU-L	-
		12	UB2-12NU-L	UB2-12SNU-L	-
		24	UB2-24NU-L	-	-
		3	UB2-3NU-L8	UB2-3SNU-L8	UB2-3NE-L8
		4.5	UB2-4.5NU-L8	UB2-4.5SNU-L8	UB2-4.5NE-L8
	Taping	5	UB2-5NU-L8	UB2-5SNU-L8	UB2-5NE-L8
	(MBB)	9	UB2-9NU-L8	UB2-9SNU-L8	-
		12	UB2-12NU-L8	UB2-12SNU-L8	-
	-	24	UB2-24NU-L8	-	-
		3	UB2-3NUN	UB2-3SNUN	UB2-3NEN
		4.5	UB2-4.5NUN	UB2-4.5SNUN	UB2-4.5NEN
		5	UB2-5NUN	UB2-5SNUN	UB2-5NEN
	Tube	9	UB2-9NUN	UB2-9SNUN	-
		12	UB2-12NUN	UB2-12SNUN	-
		24	UB2-24NUN	-	-
		3	UB2-3NUN-L	UB2-3SNUN-L	UB2-3NEN-L
		4.5	UB2-4.5NUN-L	UB2-4.5SNUN-L	UB2-4.5NEN-L
Minimum	T !	5	UB2-5NUN-L	UB2-5SNUN-L	UB2-5NEN-L
footprint	Taping	9	UB2-9NUN-L	UB2-9SNUN-L	-
		12	UB2-12NUN-L	UB2-12SNUN-L	-
		24	UB2-24NUN-L	-	-
		3	UB2-3NUN-L8	UB2-3SNUN-L8	UB2-3NEN-L8
		4.5	UB2-4.5NUN-L8	UB2-4.5SNUN-L8	UB2-4.5NEN-L8
	Taping	5	UB2-5NUN-L8	UB2-5SNUN-L8	UB2-5NEN-L8
	(MBB)	9	UB2-9NUN-L8	UB2-9SNUN-L8	-
		12	UB2-12NUN-L8	UB2-12SNUN-L8	-
		24	UB2-24NUN-L8	-	-

Note:
1. Only MBB packaging part numbers meet MSL (L8: MSL 4). However, it does not fully conform to JEDEC standards. Please note that part numbers other without MBB packaging do not meet MSL.

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□ UA2 series / High power switching type

Option		Nominal Coil Voltage	Coil Type		
Terminal	Packing	(VDC)	Non-latch	Single Coil Latch	
	Standard Tube	3	UA2-3NZF	UA2-3SNZF	
		Tuba	4.5	UA2-4.5NZF	UA2-4.5SNZF
0			5	UA2-5NZF	UA2-5SNZF
Standard		9	UA2-9NZF	UA2-9SNZF	
		12	UA2-12NZF	UA2-12SNZF	
		24	UA2-24NZF	-	

□ UB2 series / High power switching type

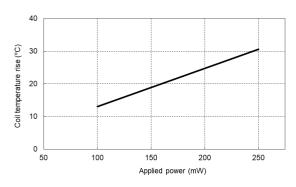
Option		Nominal Coil Voltage	Coil Type	
Terminal	Packing	(VDC)	Non-latch	Single Coil Latch
		3	UB2-3NZF-L8	UB2-3SNZF-L8
		4.5	UB2-4.5NZF-L8	UB2-4.5SNZF-L8
Standard	Taping	5	UB2-5NZF-L8	UB2-5SNZF-L8
Standard	(MBB)	9	UB2-9NZF-L8	UB2-9SNZF-L8
		12	UB2-12NZF-L8	UB2-12SNZF-L8
		24	UB2-24NZF-L8	-
	Minimum Taping	3	UB2-3NZFN-L8	UB2-3SNZFN-L8
		4.5	UB2-4.5NZFN-L8	UB2-4.5SNZFN-L8
Minimum		5	UB2-5NZFN-L8	UB2-5SNZFN-L8
footprint	(MBB)	9	UB2-9NZFN-L8	UB2-9SNZFN-L8
		12	UB2-12NZFN-L8	UB2-12SNZFN-L8
		24	UB2-24NZFN-L8	-

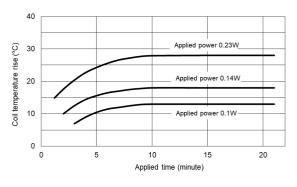
Note:

PERFORMANCE DATA

□COIL TEMPERATURE RISE

Temperature is measured by coil resistance.





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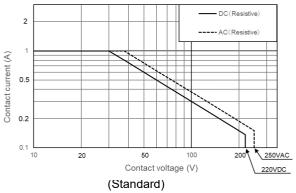
^{2.} The packaging specification for UB2 relay high power switching type is only Taping with MBB (MSL 4). Please note that other packaging specifications are not supported.

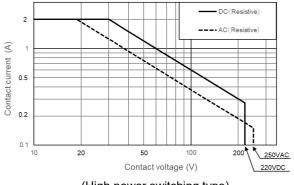


☐SWITCHING CAPACITY

This is allowed maximum value.

Inquire with EM Devices for maximum value under continuous use.



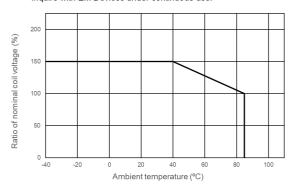


(High power switching type)

☐MAXIMUM COIL VOLTAGE

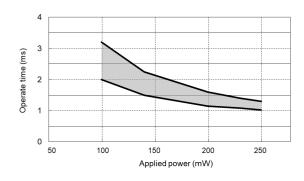
This is a maximum value of permissible alteration.

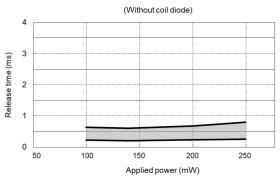
Inquire with EM Devices under continuous use.



☐ APPLIED POWER VS. TIMING

(Sample: UA2-5NU)





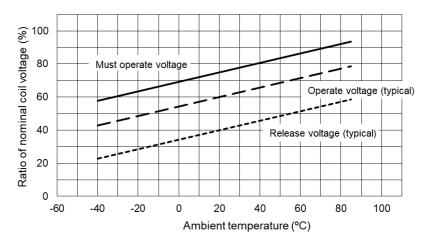
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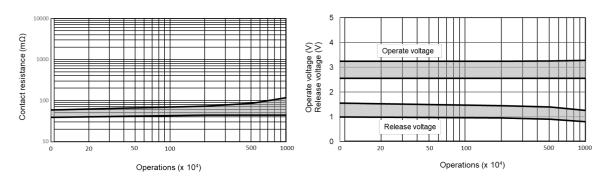
□OPERATE AND RELEASE VOLTAGE VS. AMBIENT TEMPERATURE

This shows a typical change of operate (release) voltage. The value of must operate is estimated, so coil voltage must be applied more than this value for safety operation. For hot start operation, please inquire with EM Devices.



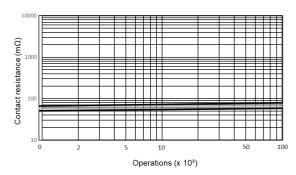
□RUNNING TEST (Non-load)

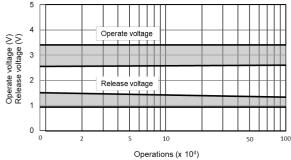
(Load: none, Drive: 5VDC, 50Hz, 50%duty, Ambient temperature: room temperature, Sample: UA2-5NU, 20pieces)



☐RUNNING TEST (Load)

(Load: 50VDC 0.1A resistive, Drive: 5VDC, 5Hz, 50%duty, Ambient temperature:85°C, Sample: UA2-5NU, 10pieces)





10

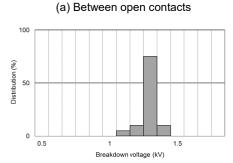
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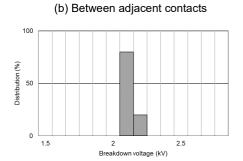
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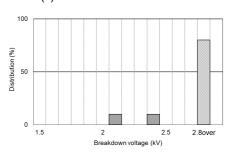
□BREAKDOWN VOLTAGE

Sample: UA2-5NU 10peices



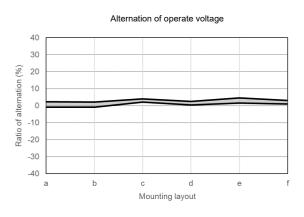


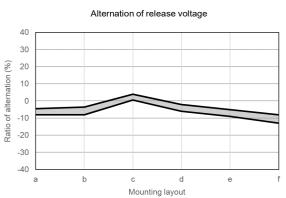
(c) Between coil and contacts

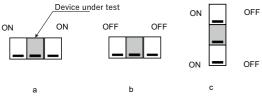


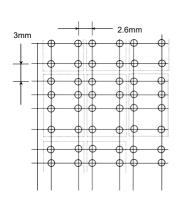
Note: Applying 2.8 kV or more may cause of breakdown outside U series relay (between terminals).

□ALTERNATION OF VOLTAGE AT DENSELY MOUNTING (Magnet interference)









ON OFF ON OFF ON OFF

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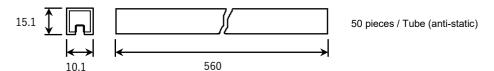
Before using the product in this catalog, please read "NOTES ON CORRECT USE" in the selection guide

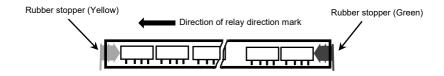
(Unit: mm)



PACKING DIMENSIONS

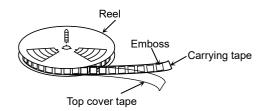
TUBE PACKING (UA2/UB2)





TAPE PACKING (UB2)

APPEARANCE



Reel material: Corrugated Cardboard (L)

PS (L8: MBB)

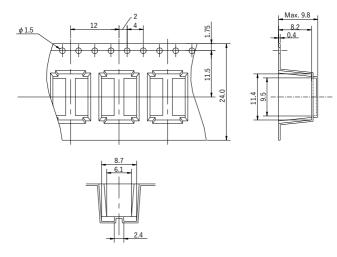
Relay quantity: 800 pieces / Reel (L)

750 pieces / Reel (L8: MBB)

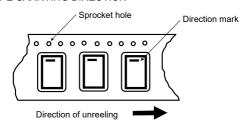
*Two reels are sealed in one MBB.

380mm Reel diameter:

TAPE DIMENSIONS



RELAY DIRECTION AND TAPE CARRYING DIRECTION



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SOLDERING TEMPERATURE CONDITION

THROUGH-HOLE MOUNTING (UA2)

1. Automatic soldering

Preheating: 110~ 120°C /110 s. (max.) Solder temperature: 260°C max.

Solder time: 5 s max.

Note: EM Devices recommends cooling down a printed circuit board less than 110°C within 40 s after soldering.

2. Manual soldering

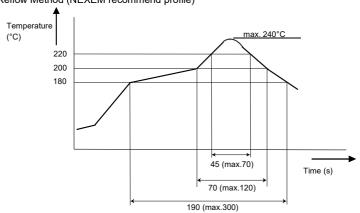
Solder temperature: 350°C max.

Solder time: 3 s max.

Note: Heating of this product by automatic soldering and manual soldering is limited to a total of three times.

SURFACE-MOUNTING TYPE (UB2)

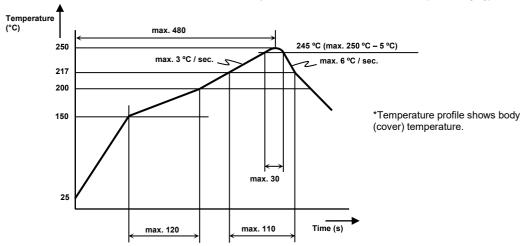
1. Reflow Method (NEXEM recommend profile)



*Temperature profile shows printed circuit board surface temperature on the relay terminal portion.

2. Reflow Method (JEDEC compliant profile)

*Product name only to meet for 250 °C reflow condition (L8 packaging)



Note:

- 1. Heating by reflow should be limited to two times. However, allow sufficient time for cooling of the product between the first
- 2. Check the actual soldering condition to use other method except above mentioned temperature profiles.

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NOTE ON CORRECT USE

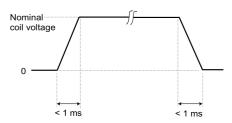
1. Notes on contact load

Make sure that the contact load is within the specified range; otherwise, the lifetime of the contacts will be shortened considerably.

Note that the running performance shown is an example, and that it varies depending on parameters such as the type of load, switching frequency, driver circuit, and ambient temperature under the actual operating conditions. Evaluate the performance by using the actual circuit before using the relay.

2. Driving relays

- If the internal connection diagram of a relay shows + and symbols on the coil, apply the rated voltage to the relay in the specified direction. If a rippled DC current source is used, abnormalities such as beat at the coil may occur.
- The maximum voltage that can be applied to the coil of the relay varies depending on the ambient temperature. Generally, the higher the voltage applied to the coil, the shorter the operating time. Note, however, that a high voltage also increases the bounce of the contacts and the contact opening and closing frequency, which may shorten the lifetime of the contacts.
- If the driving voltage waveform of the relay coil rises and falls gradually, the inherent performance of the relay may not be fully realized. Make sure that the voltage waveform instantaneously rises and falls as a pulse.

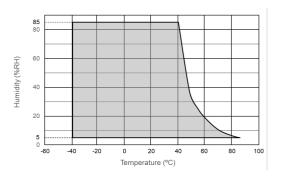


- For a latching relay, apply a voltage to the coil according to the polarity specified in the internal connection diagram of the relay.
- If a current is applied to the coil over a long period of time, the coil temperature rises, promoting generation of organic gas inside the relay, which may result in faulty contacts. In this case, use of a latching relay is recommended.
- The operating time and release time indicate the time required for each contact to close after the voltage has been applied to or removed from the coil. However, because the relay has a mechanical structure, a bounce state exists at the end of the operating and release times. Furthermore, because additional time is required until the contact stabilizes after being in a high-resistance state, care must be taken when using the relay at high speeds.

3. Operating environment

 Make sure that the relay mounted in the application set is used within the specified temperature range. Use of a relay at a temperature outside this range may adversely affect insulation or contact performance.

- If the relay is used for a long period of time in highly humid (RH 85% or higher) environment, moisture may be absorbed into the relay. This moisture may react with the NOx and SOx generated by glow discharges that occur when the contacts are opened or closed, producing nitric or sulfuric acid. If this happens, the acid produced may corrode the metallic parts of the relay, causing operational malfunction.
- If any material containing silicone (silicone rubber, silicone oil, and silicone-based coating material) is used in the neighborhood of relay, there is some possibility that these materials will emit silicone gas that will penetrate the relay. In this case, the switching contact may generate silicon compounds on the surface of contacts. This silicon compound may result in contact failure. Avoid use of relay in such an environment.
- Because the operating temperature range varies depending on the humidity, use the relay in the temperature range illustrated in the figure below. Prevent the relay from being frozen and avoid the generation of condensation.



- The same applies when the relay is stored or transported. Keep the upper-limit value of the temperature to which the relay is exposed after it is removed from the carton box to within 50°C. Please also refer to "5. Handling" for SMT relays.
- Permanent magnets are used in polarized relays. For this reason, when magnets, transformers, or speakers are located nearby the relay characteristics may change and faulty operations may result.
- The relay maintains constant sealability under normal atmospheric pressure (810 to 1,200 hPa). Its sealability may be degraded or the relay may be deformed and malfunction if it is used under barometric conditions exceeding the specified range.
- If excessive vibration or shock is applied to the relay, it may malfunction, and the contacts remain closed. Vibration or shock applied to the relay during operation may cause considerable damage to or wearing of the contacts. Note that operation of a snap switch mounted close to the relay or shock due to the operation of magnetic solenoid may also cause malfunctioning.

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lacktriangle Before using the product in this catalog, please read "NOTES ON CORRECT USE" in the selection guide



4. Notes on mounting relays

- When mounting a relay onto a PC board using an automatic chip mounter, if excessive force is applied to the cover of the relay when the relay is chucked or inserted, the cover may be damaged, or the characteristics of the relay degraded. Keep the force applied to the relay to within 1 kg.
- Avoid bending the pins to temporarily secure the relay to the PC board. Bending the pins may degrade sealability or adversely affect the internal mechanism.
- It is recommended to solder the relay onto a PC board under the following conditions:

<1> Reflow soldering

Refer to the recommended soldering temperature profile. Please note that excessive heating beyond the specified peak temperature or heating time will damage the airtightness.

<2> Flow soldering

Solder temperature: 260°C max., Time: 5 s max. Preheating: 110^{\sim} 120°C /110 s. (max.)

EM Devices recommends cooling down a printed circuit board less than 110°C within 40 seconds after soldering.

<3> Manual soldering

Solder temperature: 350°C, Time: 3 s max.

Avoid immersing the relay in cleaning solvent immediately after soldering due to the danger of thermal shock being applied to the relay.

- Use an alcohol-based or water-based cleaning solvent.
 Never use thinner and benzene because they may damage the relay housing.
- Do not use ultrasonic cleaning because the vibration energy generated by the ultrasonic waves may cause the contacts to remain closed.

5. <u>Handling</u>

- Relays are packaged in magazine cases for shipment. If a space is created in the case after some relays have been removed, be sure to insert a stopper to secure the remaining relays in the case. If relays are not well secured, vibration during transportation may cause malfunctioning of the contacts
- Exercise care in handling the relay so as to avoid dropping it or allowing it to fall. Do not use a relay that has been dropped. If a relay drops from a workbench to the floor, a shock of 9,800 m/s² (1,000 G) or more is applied to the relay, possibly damaging its functions. Even if a light shock has been applied to the relay, thoroughly evaluate its operation before using it.
- Latching relays are factory-set to the reset state for shipment.
 A latching relay may be set, however, by vibration or shock applied while being transported. Be sure to forcibly reset the relay before using it in the application set. Also note that the relay may be set by unexpected vibration or shock when it is used in a portable set.

 The sealability of a surface mount type (SMT) relay may be lost if the relay absorbs moisture and is then heated during soldering. When storing relays, therefore, observe the following points:

<1> For standard packing

(a). Pack state

Term: Less than 12 months after our shipment. (Recommend using the product as soon as possible.)

Conditions: <30 °C, <60% RH

(b). Require bake before mounting, when relays not used within the above (a) period or was stored outside above (a) conditions.

Simple relay: Please dehumidify 85 ± 5 °C, 48

hours or more after transferring to a heat-resistant container.

Tape packing: Please dehumidify 50 ± 5 °C, 300 hours or more in reel condition.

Tube packaging should be baking on simple relays, removed from tube.

Relays after baking should be mounted within 3 months under the conditions in (a).

Standard packaging specification products do not meet with the JEDEC standard's Moisture Sensitivity Level (MSL) because they are not MBB packaged. If MSL compliance is required, use MBB packaging specification products.

<2> For MBB packing

(a). MBB state

Term: Less than 12 months after our shipment Conditions: <30 °C, <60% RH

(b). After opening of MBB

Term: Within the time limit indicated on the

Conditions: <30 °C, <60% RH

(c). Require bake before mounting, when relays not used within the above (a) or (b) period or was stored outside above conditions.

Simple relay: Please dehumidify 85 ± 5 °C, 48 hours or more after transferring to a heat-resistant container.

Tape packing: Please dehumidify 50 ± 5 °C, 300 hours or more in reel condition.

Please keep in mind that barrier pack needs to remove in that case.

Relays after baking should be mounted within the time limits according to MSL on the caution label under the conditions in (b).

The humidity indicator card included in MBB package immediately after opening should also be used as a basis for judging baking procedures.

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